# **PCA21125**

# SPI-bus Real-Time Clock and calendar Rev. 2 — 25 November 2014

**Product data sheet** 

#### 1. **General description**

The PCA21125 is a CMOS<sup>1</sup> Real-Time Clock (RTC) and calendar optimized for low-power consumption and an operating temperature up to 125 °C. Data is transferred via a Serial Peripheral Interface (SPI-bus) with a maximum data rate of 6.0 Mbit/s. Alarm and timer functions are also available with the possibility to generate a wake-up signal on the interrupt pin.

For a selection of NXP Real-Time Clocks, see Table 46 on page 41

#### **Features and benefits** 2.

- AEC Q100 compliant for automotive applications.
- Provides year, month, day, weekday, hours, minutes, and seconds based on 32.768 kHz quartz crystal
- Resolution: seconds to years
- Clock operating voltage: 1.3 V to 5.5 V
- Low supply current: typical 0.8 μA at T<sub>amb</sub> = 25 °C
- 4-line SPI-bus with separate, but combinable data input and output
- Serial interface at V<sub>DD</sub> = 1.6 V to 5.5 V
- 1 second or 1 minute interrupt output
- Freely programmable timer with interrupt capability
- Freely programmable alarm function with interrupt capability
- Integrated oscillator capacitor
- Internal Power-On Reset (POR)
- Open-drain interrupt pin

# 3. Applications

- Automotive time keeping
- Metering

The definition of the abbreviations and acronyms used in this data sheet can be found in Section 21.



# **SPI-bus Real-Time Clock and calendar**

# 4. Ordering information

Table 1. Ordering information

Type number	Package				
	Name	Description	Version		
PCA21125T	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1		

# 4.1 Ordering options

# Table 2. Ordering options

Product type number	Orderable part number	Sales item (12NC)	Delivery form	IC revision
PCA21125T/Q900/1	PCA21125T/Q900/1,1	935290408118	tape and reel, 13 inch	1

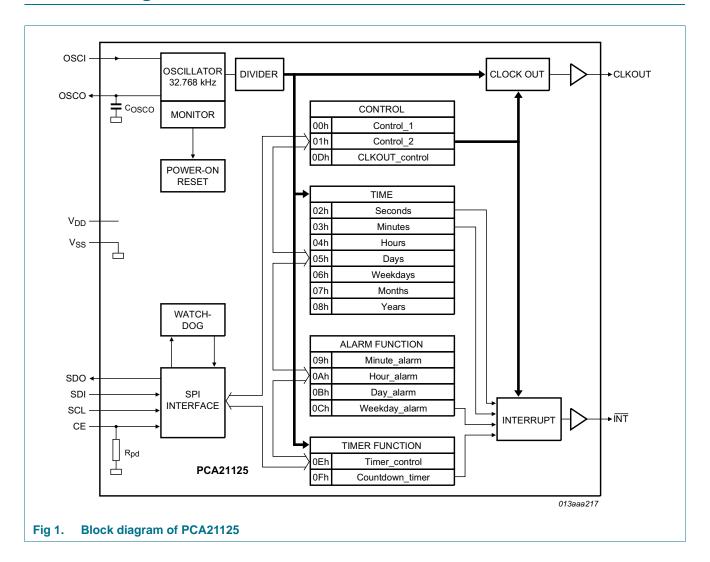
# 5. Marking

# Table 3. Marking codes

Type number	Marking code
PCA21125T/Q900/1	PC21125

### SPI-bus Real-Time Clock and calendar

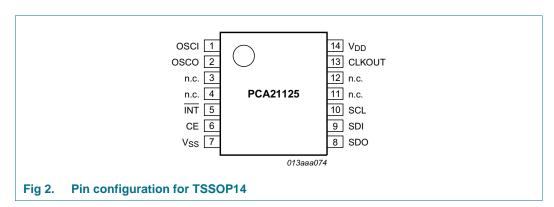
# 6. Block diagram



# **SPI-bus Real-Time Clock and calendar**

# 7. Pinning information

# 7.1 Pinning



# 7.2 Pin description

### Table 4. Pin description

Input or input/output pins must always be at a defined level ( $V_{SS}$  or  $V_{DD}$ ) unless otherwise specified.

Symbol	Pin	Description
OSCI	1	oscillator input
OSCO	2	oscillator output
n.c.	3, 4	not connected; do not connect and do not use as feed through; connect to $V_{\text{DD}}$ if floating pins are not allowed
ĪNT	5	interrupt output (open-drain; active LOW)
CE	6	chip enable input (active HIGH) with 200 kΩ pull-down resistor
$V_{SS}$	7	ground supply voltage
SDO	8	serial data output, push-pull
SDI	9	serial data input; might float when CE inactive
SCL	10	serial clock input; might float when CE inactive
n.c.	11, 12	not connected; do not connect and do not use as feed through; connect to $V_{\text{DD}}$ if floating pins are not allowed
CLKOUT	13	clock output (open-drain)
$V_{DD}$	14	supply voltage

#### SPI-bus Real-Time Clock and calendar

# 8. Functional description

The PCA21125 contains 16 8-bit registers with an auto-incrementing address register, an on-chip 32.768 kHz oscillator with one integrated capacitor, a frequency divider which provides the source clock for the RTC, a programmable clock output, and a 6 MHz SPI-bus.

All 16 registers are designed as addressable 8-bit parallel registers although not all bits are implemented:

- The first two registers at addresses 00h and 01h (Control\_1 and Control\_2) are used as control and status registers.
- Registers at addresses 02h to 08h (Seconds, Minutes, Hours, Days, Weekdays, Months, Years) are used as counters for the clock function. Seconds, minutes, hours, days, months, and years are all coded in Binary Coded Decimal (BCD) format. When one of the RTC registers is written or read, the contents of all counters are frozen. Therefore, faulty writing or reading of time and date during a carry condition is prevented.
- Registers at addresses 09h to 0Ch (Minute\_alarm, Hour\_alarm, Day\_alarm, and Weekday\_alarm) define the alarm condition.
- The register at address 0Dh (CLKOUT\_control) defines the clock output mode.
- Registers at addresses 0Eh and 0Fh (Timer\_control and Countdown\_timer) are used
  for the countdown timer function. The countdown timer has four selectable source
  clocks allowing for countdown periods in the range from less than 1 ms to more than
  4 hours (see <u>Table 30</u>). There are also two pre-defined timers which can be used to
  generate an interrupt once per second or once per minute. These are defined in
  register Control\_2 (01h).

# **SPI-bus Real-Time Clock and calendar**

# 8.1 Register overview

The time, date, and alarm registers are encoded in BCD to simplify application use. Other registers are either bit-wise or standard binary.

Table 5. Register overview

Bits labeled - are not implemented and return logic 0 when read. Bit positions labeled N should always be written with logic 0. After reset, all registers are set according to <u>Table 38 on page 26</u>.

Address	Register name	Bit	Bit								
		7	6	5	4	3	2	1	0		
Control a	nd status registers	3			'		'	'			
00h	Control_1	EXT_TEST	N	STOP	N	POR_OVRD	12_24	N	N		
01h	Control_2	MI	SI	MSF	TI_TP	AF	TF	AIE	TIE		
Time and	date registers						'	'			
02h	Seconds	RF	SECOND	S (0 to 59)							
03h	Minutes	-	MINUTES	MINUTES (0 to 59)							
04h	Hours	-	-	AMPM	HOURS	(1 to 12) in 12-h	our mode				
		-	-	HOURS	(0 to 23) in	24-hour mode					
05h	Days	-	-	DAYS (1 to 31)							
06h	Weekdays	-	-	-	-	-	WEEKDA	YS (0 to	6)		
07h	Months	-	-	-	- MONTHS (1 to 12)						
08h	Years	YEARS (0 to	99)								
Alarm reg	gisters										
09h	Minute_alarm	AEN_M	MINUTE_	_ALARM (C	to 59)						
0Ah	Hour_alarm	AEN_H	-	AMPM	HOUR_A	LARM (1 to 12)	in 12-hou	r mode			
			-	HOUR_A	LARM (0 to	o 23) in 24-houi	r mode				
0Bh	Day_alarm	AEN_D	-	DAY_ALA	ARM (1 to 3	31)					
0Ch	Weekday_alarm	AEN_W	-	-	-	-	WEEKDA	Y_ALARI	M (0 to 6)		
CLKOUT	control register										
0Dh	CLKOUT_control	-	-	COF[2:0]							
Timer reg	jisters					•					
0Eh	Timer_control	TE	-	-	-	-	-	CTD[1:0	)]		
0Fh	Countdown_timer	T[7:0]		·	•	•	·	•			

### SPI-bus Real-Time Clock and calendar

# 8.2 Control and status registers

# 8.2.1 Register Control\_1

Table 6. Control\_1 - control and status register 1 (address 00h) bit description

Bit	Symbol	Value	Description	Reference	
7	EXT_TEST	0[1]	normal mode	Section 8.8	
		1	external clock test mode		
6	N	0	unused	-	
5	STOP	0[1]	RTC source clock runs	Section 8.9	
		1	RTC clock is stopped <sup>[2]</sup>		
4	N	0	unused	-	
3	POR_OVRD	0	Power-On Reset Override facility is disabled;	Section 8.10.1	
			Remark: set logic 0 for normal operation		
		1 <u>[1]</u>	Power-On Reset Override sequence reception enabled		
2	12_24	0[1]	24-hour mode selected	Table 11 and Table 19	
		1	12-hour mode selected		
1 to 0	N	00	unused	-	

<sup>[1]</sup> Default value.

# 8.2.2 Register Control\_2

Table 7. Control\_2 - control and status register 2 (address 01h) bit description

Bit	Symbol	Value	Description	Reference
7	MI	O[1]	minute interrupt disabled	Section 8.6.1
		1	minute interrupt enabled	
6	SI	O[1]	second interrupt disabled	Section 8.6.1
		1	second interrupt enabled	
5	MSF	0[1]	no minute or second interrupt generated	Section 8.6.1
		1	flag set when minute or second interrupt generated	
4	TI_TP	0[1]	interrupt pin follows TF and MSF (see Figure 9)	Section 8.6 et seq. and
		1	interrupt pin generates a pulse	Section 8.7 et seq.
3	AF	0[1]	no alarm interrupt generated	Section 8.4.5
		1	flag set when alarm triggered;	
			Remark: flag must be cleared to clear interrupt	
2	TF	0[1]	no countdown timer interrupt generated	Section 8.6 et seq. and
		1	flag set when countdown timer interrupt generated	Section 8.7 et seq.
1	AIE	0[1]	no interrupt generated from alarm flag	Section 8.7.3
		1	interrupt generated when alarm flag set	
0	TIE 0[1]		no interrupt generated from countdown timer flag	Section 8.7
		1	interrupt generated when countdown timer flag set	

<sup>[1]</sup> Default value.

<sup>[2]</sup> CLKOUT at 32.768 kHz, 16.384 kHz or 8.192 kHz is still available; divider chain flip-flops are asynchronously set logic 0.

### **SPI-bus Real-Time Clock and calendar**

# 8.3 Time and date registers

Most of these registers are coded in the Binary Coded Decimal (BCD) format. BCD is used to simplify application use. An example is shown for register Seconds in Table 9.

Loading these registers with values outside of the given range results in unpredictable time and date generation (see <u>Figure 3 "Data flow of the time function"</u>).

# 8.3.1 Register Seconds

Table 8. Seconds - seconds and clock integrity status register (address 02h) bit description

Bit	Symbol	Value	Description
7	RF	0	clock integrity is guaranteed
		1[1]	clock integrity is not guaranteed;
			chip reset has occurred since flag was last cleared
6 to 4	SECONDS	0 to 5	ten's place
3 to 0		0 to 9	unit place

<sup>[1]</sup> Start-up value.

Table 9. Seconds coded in BCD format

Seconds value in	Upper-dig	it (ten's pla	place) Digit (unit place)				
decimal	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
00	0	0	0	0	0	0	0
01	0	0	0	0	0	0	1
02	0	0	0	0	0	1	0
:		:		:	:		:
09	0	0	0	1	0	0	1
10	0	0	1	0	0	0	0
:		:		:	:		:
58	1	0	1	1	0	0	0
59	1	0	1	1	0	0	1

# 8.3.2 Register Minutes

Table 10. Minutes - minutes register (address 03h) bit description

Bit	Symbol	Value	Description
7	-	0	unused
6 to 4	MINUTES	0 to 5	ten's place
3 to 0		0 to 9	unit place

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# 8.3.3 Register Hours

Table 11. Hours - hours register (address 04h) bit description

Bit	Symbol	Value	Description			
7 to 6	-	00	unused			
12-hour	12-hour mode[1]					
5	AMPM	0	indicates AM			
		1	indicates PM			
4	HOURS	0 to 1	ten's place			
3 to 0		0 to 9	unit place			
24-hour mode <sup>[1]</sup>						
5 to 4	HOURS	0 to 2	ten's place			
3 to 0		0 to 9	unit place			

<sup>[1]</sup> Hour mode is set by bit 12\_24 in register Control\_1 (see Table 6).

# 8.3.4 Register Days

Table 12. Days - days register (address 05h) bit description

Bit	Symbol	Value	Place value	Description
7 to 6	-	00	-	unused
5 to 4	DAYS[1]	0 to 3	ten's place	actual day coded in BCD format
3 to 0		0 to 9	unit place	

<sup>[1]</sup> The PCA21125 compensates for leap years by adding a 29th day to February if the year counter contains a value which is exactly divisible by 4, including the year 00.

# 8.3.5 Register Weekdays

Table 13. Weekdays - weekdays register (address 06h) bit description

Bit	Symbol	Value	Description
7 to 3	-	00000	unused
2 to 0	WEEKDAYS	0 to 6	actual weekday, values see Table 14

Table 14. Weekday assignments

Day[1]	Bit						
	2	1	0				
Sunday	0	0	0				
Monday	0	0	1				
Tuesday	0	1	0				
Wednesday	0	1	1				
Thursday	1	0	0				
Friday	1	0	1				
Saturday	1	1	0				

<sup>[1]</sup> Definition may be reassigned by the user.

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# 8.3.6 Register Months

Table 15. Months - months register (address 07h) bit description

Bit	Symbol	Value	Description
7 to 5	-	000	unused
4	MONTHS	0 to 1	ten's place
3 to 0		0 to 9	unit place

Table 16. Month assignments in BCD format

Month	Upper-digit (ten's place)	Digit (unit place)						
	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
January	0	0	0	0	1			
February	0	0	0	1	0			
March	0	0	0	1	1			
April	0	0	1	0	0			
May	0	0	1	0	1			
June	0	0	1	1	0			
July	0	0	1	1	1			
August	0	1	0	0	0			
September	0	1	0	0	1			
October	1	0	0	0	0			
November	1	0	0	0	1			
December	1	0	0	1	0			

# 8.3.7 Register Years

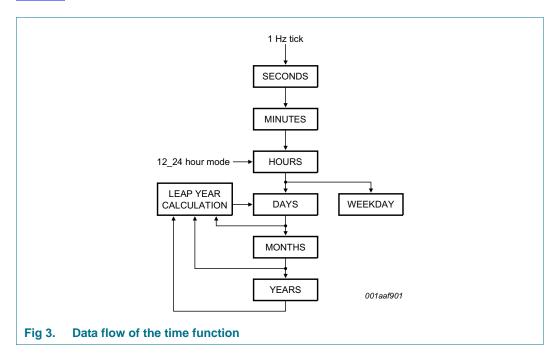
Table 17. Years - years register (08h) bit description

Bit	Symbol	Value	Place value	Description
7 to 4	YEARS	0 to 9	ten's place	actual year coded in BCD format
3 to 0		0 to 9	unit place	

#### SPI-bus Real-Time Clock and calendar

# 8.3.8 Setting and reading the time

Figure 3 shows the data flow and data dependencies starting from the 1 Hz clock tick.

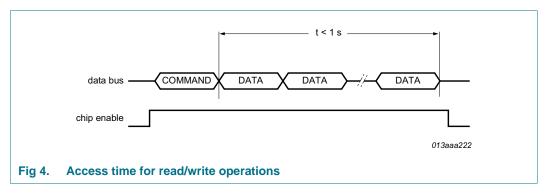


During read/write operations, the time counting circuits (memory locations 02h through 08h) are blocked.

# This prevents

- Faulty reading of the clock and calendar during a carry condition
- · Incrementing the time registers during the read cycle

After this read/write access is completed, the time circuit is released again and any pending request to increment the time counters that occurred during the read/write access is serviced. A maximum of 1 request can be stored; therefore, all accesses must be completed within 1 second (see Figure 4).



As a consequence of this method, it is very important to make a read or write access in one go, that is, setting or reading seconds through to years should be made in one single access. Failing to comply with this method could result in the time becoming corrupted.

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As an example, if the time (seconds through to hours) is set in one access and then in a second access the date is set, it is possible that the time may increment between the two accesses. A similar problem exists when reading. A roll-over may occur between reads thus giving the minutes from one moment and the hours from the next. Therefore it is advised to read all time and date registers in one access.

# 8.4 Alarm registers

When one or several alarm registers are loaded with a valid minute, hour, day, or weekday value and its corresponding alarm enable bit (AEN\_X) is logic 0, then that information is compared with the current minute, hour, day, and weekday value.

# 8.4.1 Register Minute\_alarm

Table 18. Minute\_alarm - minute alarm register (address 09h) bit description

Bit	Symbol	Value	Place value	Description
7	AEN_M	0	-	minute alarm is enabled
		1[1]	-	minute alarm is disabled
6 to 4	MINUTE_ALARM	0 to 5	ten's place	minute alarm information coded in
3 to 0		0 to 9	unit place	BCD format

<sup>[1]</sup> Default value.

# 8.4.2 Register Hour\_alarm

Table 19. Hour\_alarm - hour alarm register (address 0Ah) bit description

Bit	Symbol	Value	Description		
7	AEN_H	0	hour alarm is enabled		
		1[1]	hour alarm is disabled		
6	-	0	unused		
12-hour mode <sup>[2]</sup>					
5	AMPM	0	indicates AM		
		1	indicates PM		
4	HOUR_ALARM	0 to 1	ten's place		
3 to 0		0 to 9	unit place		
24-hour mode <sup>[2]</sup>					
5 to 4	HOURS	0 to 2	ten's place		
3 to 0		0 to 9	unit place		

<sup>[1]</sup> Default value.

<sup>[2]</sup> Hour mode is set by bit 12\_24 in register Control\_1 (see Table 6).

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# 8.4.3 Register Day\_alarm

Table 20. Day\_alarm - day alarm register (address 0Bh) bit description

Bit	Symbol	Value	Place value	Description
7	AEN_D	0	-	day alarm is enabled
		1[1]	-	day alarm is disabled
6	-	0	-	unused
5 to 4	DAY_ALARM	0 to 3	ten's place	day alarm information coded in BCD
3 to 0		0 to 9	unit place	format

<sup>[1]</sup> Default value.

# 8.4.4 Register Weekday\_alarm

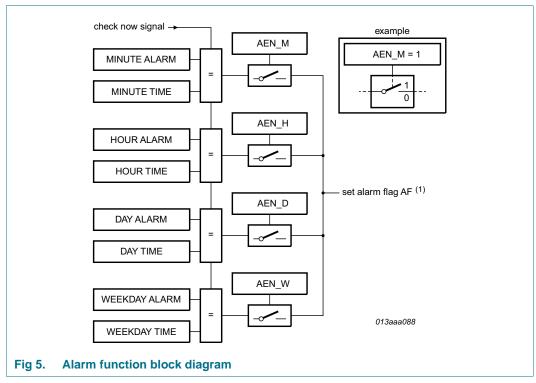
Table 21. Weekday\_alarm - weekday alarm register (address 0Ch) bit description

Bit	Symbol	Value	Description
7	AEN_W	0	weekday alarm is enabled
		1[1]	weekday alarm is disabled
6 to 3	-	0000	unused
2 to 0	WEEKDAY_ALARM	0 to 6	weekday alarm information coded in BCD format

<sup>[1]</sup> Default value.

# 8.4.5 Alarm flag

By clearing the MSB, AEN\_X (Alarm Enable), of one or more of the alarm registers the corresponding alarm condition(s) are active. When an alarm occurs, AF (register Control\_2, see <a href="Table 7">Table 7</a>) is set logic 1. The asserted AF can be used to generate an interrupt (INT). The AF is cleared by command.



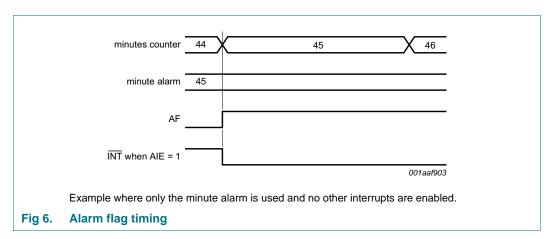
#### SPI-bus Real-Time Clock and calendar

The registers at addresses 09h through 0Ch contain alarm information. When one or more of these registers is loaded with minute, hour, day, or weekday, and its corresponding Alarm Enable bit (AEN\_X) is logic 0, then that information is compared with the current minute, hour, day, and weekday. When all enabled comparisons first match, the Alarm Flag (AF) is set logic 1.

The generation of interrupts from the alarm function is controlled via bit AIE (register Control\_2, see <u>Table 7</u>). If bit AIE is enabled, the <u>INT</u> pin follows the condition of bit AF. AF remains set until cleared by the interface. Once AF has been cleared, it is only set again when the time increments to match the alarm condition once more. Alarm registers which have their AEN\_X bit logic 1 are ignored.

Generation of interrupts from the alarm function is described in <u>Section 8.7.3</u>.

<u>Figure 6, Table 22</u> and <u>Table 23</u> show an example for clearing bit AF, but leaving bit MSF and bit TF unaffected. The flags are cleared by a write command, therefore bits 7, 6, 4, 1 and 0 must be written with their previous values. Repeatedly rewriting these bits has no influence on the functional behavior.



To prevent the timer flags being overwritten while clearing bit AF, logic AND is performed during a write access. A flag is cleared by writing logic 0 while a flag is not cleared by writing logic 1. Writing logic 1 results in the flag value remaining unchanged.

Table 22. Flag location in register Control\_2

Register	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Control_2	-	-	MSF	-	AF	TF	-	-

<u>Table 23</u> shows what instruction must be sent to clear bit AF. In this example, bit MSF and bit TF are unaffected.

Table 23. Example to clear only AF (bit 3) in register Control\_2

Register	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Control_2	-	-	1	-	0	1	-	-

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# 8.5 Register CLKOUT\_control and clock output

A programmable square wave is available at pin CLKOUT. Operation is controlled by control bits COF[2:0] in register CLKOUT\_control (0Dh); see <u>Table 24</u>. Frequencies of 32.768 kHz (default) down to 1 Hz can be generated for use as a system clock, microcontroller clock, input to a charge pump, or for calibration of the oscillator.

Table 24. CLKOUT\_control - CLKOUT control register (address 0Dh) bit description

Bit	Symbol	Value	Description
7 to 3	-	00000	unused
2 to 0	COF[2:0]	see Table 25	frequency output at pin CLKOUT

Pin CLKOUT is an open-drain output and enabled at power-on. When disabled the output is LOW.

The duty cycle of the selected clock is not controlled, but due to the nature of the clock generation, all clock frequencies, except 32.768 kHz, have a duty cycle of 50 : 50.

The stop function can also affect the CLKOUT signal, depending on the selected frequency. When STOP is active, the CLKOUT pin generates a continuous LOW for those frequencies that can be stopped. For more details, see Section 8.9.

Table 25. CLKOUT frequency selection

Bits COF[2:0]	CLKOUT frequency (Hz)	Typical duty cycle[1] (%)	Effect of STOP
000[2]	32768	60 : 40 to 40 : 60	no effect
001	16384	50 : 50	no effect
010	8192	50 : 50	no effect
011	4096	50 : 50	CLKOUT = LOW
100	2048	50 : 50	CLKOUT = LOW
101	1024	50 : 50	CLKOUT = LOW
110	1	50 : 50	CLKOUT = LOW
111	CLKOUT = LOW	'	

<sup>[1]</sup> Duty cycle definition: HIGH-level time (%): LOW-level time (%).

# 8.6 Timer registers

The countdown timer has four selectable source clocks allowing for countdown periods in the range from less than 1 ms to more than 4 hours (see <u>Table 30</u>). There are also two pre-defined timers which can be used to generate an interrupt once per second or once per minute.

Registers Control\_2 (01h), Timer\_control (0Eh), and Countdown\_timer (0Fh) are used to control the timer function and output.

<sup>[2]</sup> Default value.

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Table 26. Timer\_control - timer control register (address 0Eh) bit description

Bit	Symbol	Value	Description	Reference
7	TE	0[1]	countdown timer is disabled	Section 8.6.2
		1	countdown timer is enabled	
6 to 2	-	00000	unused	
1 to 0	CTD[1:0]	00	4.096 kHz countdown timer source clock	
		01	64 Hz countdown timer source clock	
		10	1 Hz countdown timer source clock	
		11[1]	1/60 Hz countdown timer source clock	

<sup>[1]</sup> Default value.

Table 27. Countdown timer - countdown timer register (address 0Fh) bit description

Bit	Symbol	Value	Description	Reference
7 to 0	T[7:0]	0h to FFh	countdown timer value[1]	Section 8.6.2

<sup>[1]</sup> Countdown period in seconds:  $CountdownPeriod = \frac{T}{SourceClockFrequency}$  where T is the countdown value.

### 8.6.1 Second and minute interrupt

The second and minute interrupts (bits SI and MI) are pre-defined timers for generating periodic interrupts. The timers can be enabled independently of one another, however a minute interrupt enabled on top of a second interrupt is not distinguishable since it occurs at the same time; see Figure 7.

The minute and second flag (MSF) is set logic 1 when either the seconds or the minutes counter increments according to the currently enabled interrupt. The flag can be read and cleared by the interface. The status of bit MSF does not affect the  $\overline{\text{INT}}$  pulse generation. If the MSF flag is not cleared prior to the next coming interrupt period, an  $\overline{\text{INT}}$  pulse will still be generated.

Table 28. Effect of bits MI and SI on INT generation

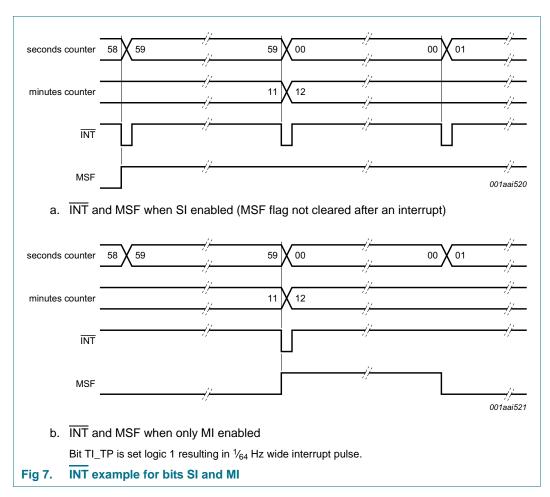
Minute interrupt (bit MI)	Second interrupt (bit SI)	Result
0	0	no interrupt generated
1	0	an interrupt once per minute
0	1	an interrupt once per second
1	1	an interrupt once per second

Table 29. Effect of bits MI and SI on bit MSF

Minute interrupt (bit MI)	Second interrupt (bit SI)	Result
0	0	MSF never set
1	0	MSF set when minutes counter increments[1]
0	1	MSF set when <b>seconds</b> counter increments
1	1	MSF set when <b>seconds</b> counter increments

<sup>[1]</sup> If bit MI = 1 and bit SI = 0, bit MSF is cleared automatically after 1 second.

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The purpose of the flag is to allow the controlling system to interrogate the PCA21125 and identify the source of the interrupt such as the minute/second or countdown timer.

### 8.6.2 Countdown timer function

The 8-bit countdown timer at address 0Fh is controlled by the timer control register at address 0Eh. The timer control register determines one of 4 source clock frequencies for the timer (4.096 kHz, 64 Hz, 1 Hz, or  $\frac{1}{60}$  Hz) and enables or disables the timer.

Table 30. CTD[1:0] for timer frequency selection and countdown timer durations

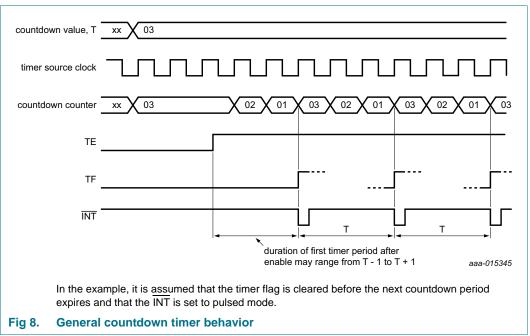
CTD[1:0]	Timer source clock	Delay				
	frequency	Minimum timer duration T = 1	Maximum timer duration T = 255			
00	4.096 kHz	244 μs	62.256 ms			
01	64 Hz	15.625 ms	3.984 s			
10	1 Hz	1 s	255 s			
11	1/ <sub>60</sub> Hz	60 s <sup>[1]</sup>	4 h 15 min			

[1] When not in use, CTD[1:0] must be set to  $\frac{1}{60}$  Hz for power saving.

**Remark:** Note that all timings which are generated from the 32.768 kHz oscillator are based on the assumption that there is 0 ppm deviation. Deviation in oscillator frequency results in a corresponding deviation in timings. This is not applicable to interface timing.

#### SPI-bus Real-Time Clock and calendar

The timer counts down from a software-loaded 8-bit binary value T. Loading the counter with 0 effectively stops the timer. Values from 1 to 255 are valid. When the counter reaches 1, the countdown timer flag (bit TF in register Control\_2, see <u>Table 7</u>) will be set and the counter automatically reloads and starts the next timer period. Reading the timer returns the current value of the countdown counter; see <u>Figure 8</u>.



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If a new value of T is written before the end of the current timer period, then this new value takes immediate effect. It is not recommended to change T without first disabling the counter (by setting bit TE = 0). The update of T is asynchronous with the timer clock, therefore changing it without setting bit TE = 0 results in a corrupted value loaded into the countdown counter which results in an undetermined countdown period for the first period. The countdown value T will however be correctly stored and correctly loaded on subsequent timer periods.

When the countdown timer flag is set, an interrupt signal on  $\overline{\text{INT}}$  is generated, if this mode is enabled. See Section 8.7.2 for details on how the interrupt can be controlled.

When starting the timer for the first time, the first period has an uncertainty which is a result of the enable instruction being generated from the interface clock which is asynchronous with the timer source clock. Subsequent timer periods have no such delay. The amount of delay for the first timer period depends on the chosen source clock; see <a href="Table 31">Table 31</a>.

Table 31. First period delay for timer counter value T

Timer source clock	Minimum timer period	Maximum timer period
4.096 kHz	Т	T + 1
64 Hz	Т	T + 1
1 Hz	(T – 1) + ½ Hz	T + <sup>1</sup> / <sub>64</sub> Hz
½0 Hz	(T – 1) + ½ Hz	T + <sup>1</sup> / <sub>64</sub> Hz

#### SPI-bus Real-Time Clock and calendar

At the end of every countdown, the timer sets the countdown timer flag (bit TF). Bit TF can only be cleared by command. The asserted bit TF can be used to generate an interrupt (INT). The interrupt can be generated as a pulsed signal every countdown period or as a permanently active signal which follows the condition of bit TF. Bit TI\_TP is used to control this mode selection and the interrupt output can be disabled with bit TIE.

For accurate read back of the count down value, it is recommended to read the register twice and check for consistent results, since it is not possible to freeze the countdown timer counter during read back.

# 8.6.3 Timer flags

When a minute or second interrupt occurs, bit MSF (register Control\_2, see <u>Table 7</u>) is set logic 1. Similarly, at the end of a timer countdown bit TF is set logic 1. These bits maintain their value until overwritten by command. If both countdown timer and minute/second interrupts are required in the application, the source of the interrupt can be determined by reading these bits. To prevent one flag being overwritten while clearing another, a logic AND is performed during a write access. A flag is cleared by writing logic 0 while a flag is not cleared by writing logic 1. Writing logic 1 results in the flag value remaining unchanged.

Three examples are given for clearing the flags. Flags MSF and TF are cleared by a write command, therefore bits 7, 6, 4, 1, and 0 must be written with their previous values. Repeatedly rewriting these bits has no influence on the functional behavior.

Table 32. Flag location in register Control\_2

Register	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Control_2	-	-	MSF	-	AF	TF	-	-

<u>Table 33</u>, <u>Table 34</u>, and <u>Table 35</u> show what instruction must be sent to clear the appropriate flag.

Table 33. Example to clear only TF (bit 2) in register Control\_2

Register	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Control_2	-	-	1	-	1	0	-	-

Table 34. Example to clear only MSF (bit 5) in register Control\_2

Register	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Control_2	-	-	0	-	1	1	-	-

Table 35. Example to clear both TF and MSF (bits 2 and 5) in register Control\_2

Register	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Control_2	-	-	0	-	1	0	-	-

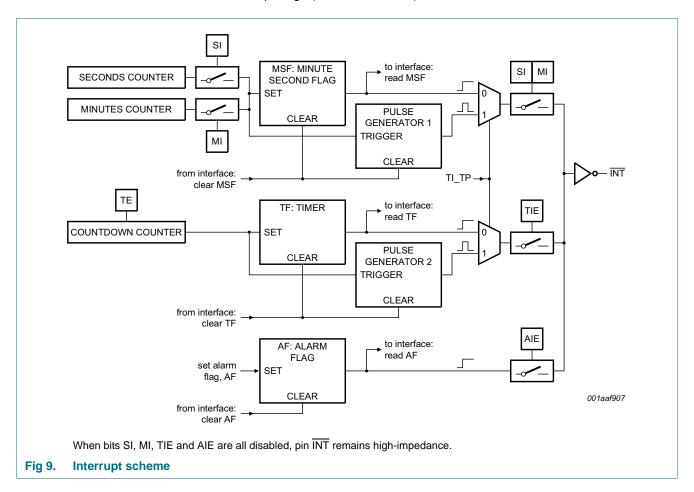
Clearing the alarm flag (bit AF) operates in the same way; see <u>Section 8.4.5</u>.

#### SPI-bus Real-Time Clock and calendar

# 8.7 Interrupt output

An active LOW interrupt signal is available at pin  $\overline{\text{INT}}$ . Operation is controlled via the bits of register Control\_2. Interrupts can be sourced from three places: second/minute timer, countdown timer, and alarm function.

Bit TI\_TP configures the timer generated interrupts to be either a pulse or to follow the status of the interrupt flags (bits TF and MSF).



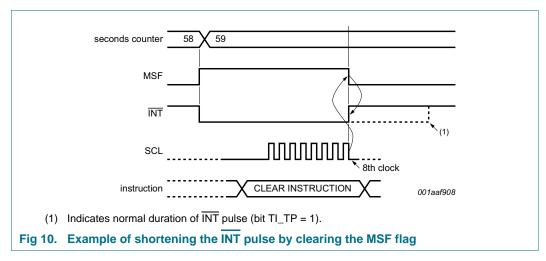
**Remark:** Note that the interrupts from the three groups are wired-OR, meaning they will mask one another; see Figure 9.

### 8.7.1 Minute and second interrupts

The pulse generator for the minute/second interrupt operates from an internal 64 Hz clock and consequently generates a pulse of  $\frac{1}{64}$  second duration.

If the MSF flag is clear before the end of the  $\overline{\text{INT}}$  pulse, then the  $\overline{\text{INT}}$  pulse is shortened. This allows the source of a system interrupt to be cleared immediately it is serviced, i.e., the system does not have to wait for the completion of the pulse before continuing; see <u>Figure 10</u>. Instructions for clearing MSF are given in <u>Section 8.6.3</u>.

#### SPI-bus Real-Time Clock and calendar



The timing shown for clearing bit MSF in <u>Figure 10</u> is also valid for the non-pulsed interrupt mode, i.e., when bit TI\_TP = 0, where the pulse can be shortened by setting both bits MI and SI logic 0.

### 8.7.2 Countdown timer interrupts

Generation of interrupts from the countdown timer is controlled via bit TIE (register Control\_2, see Table 7).

The pulse generator for the countdown timer interrupt also uses an internal clock which is dependent on the selected source clock for the countdown timer and on the countdown value T. As a consequence, the width of the interrupt pulse varies; see Table 36.

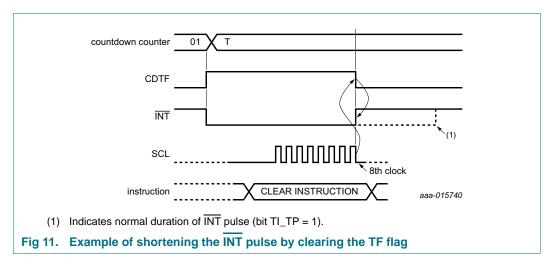
Table 36. INT operation (bit TI\_TP = 1)

Source clock (Hz)	INT period (s)				
	T = 1[1]	T > 1			
4096	1/8192	1⁄4096			
64	1/128	1/64			
1	1/64	1/64			
1/60	1/64	1/64			

[1] T = loaded countdown value. Timer stopped when T = 0.

If the TF flag is cleared before the end of the  $\overline{\text{INT}}$  pulse, then the  $\overline{\text{INT}}$  pulse is shortened. This allows the source of a system interrupt to be cleared immediately it is serviced, i.e., the system does not have to wait for the completion of the pulse before continuing; see Figure 11. Instructions for clearing TF are given in Section 8.6.3.

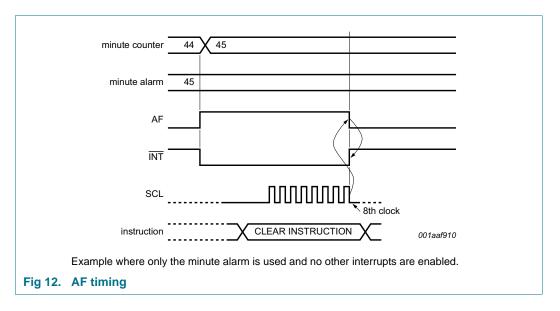
#### SPI-bus Real-Time Clock and calendar



The timing shown for clearing bit TF in Figure 11 is also valid for the non-pulsed interrupt mode, i.e., when bit  $TI\_TP = 0$ , where the pulse can be shortened by setting bit TIE = 0.

### 8.7.3 Alarm interrupts

Generation of interrupts from the alarm function is controlled via bit AIE (register Control\_2, see <u>Table 7</u>). If bit AIE is <u>enabled</u>, the <u>INT</u> pin follows the status of bit AF. Clearing bit AF immediately clears <u>INT</u>. No pulse generation is possible for alarm interrupts; see <u>Figure 12</u>.



### 8.8 External clock test mode

A test mode is available which allows for on-board testing. In this mode, it is possible to set up test conditions and control the operation of the RTC.

The test mode is entered by setting the EXT\_TEST bit in register Control\_1 (see <u>Table 6</u>). The CLKOUT pin then becomes an input. The test mode replaces the internal signal with the signal applied to pin CLKOUT.

#### SPI-bus Real-Time Clock and calendar

The signal applied to pin CLKOUT should have a minimum pulse width of 300 ns and a maximum period of 1000 ns. The internal clock, now sourced from pin CLKOUT, is divided down to 1 Hz by a 2<sup>6</sup> divide chain called a prescaler; see <u>Section 8.9</u>. The prescaler can be set into a known state by using the STOP bit. When the STOP bit is set, the prescaler is reset to 0. (STOP must be cleared before the prescaler can operate again.)

From a stop condition, the first 1 second increment will take place after 32 positive edges on pin CLKOUT. Thereafter, every 64 positive edges cause a 1 second increment.

**Remark:** Entry into test mode is not synchronized to the internal 64 Hz clock. When entering the test mode, no assumption as to the state of the prescaler can be made.

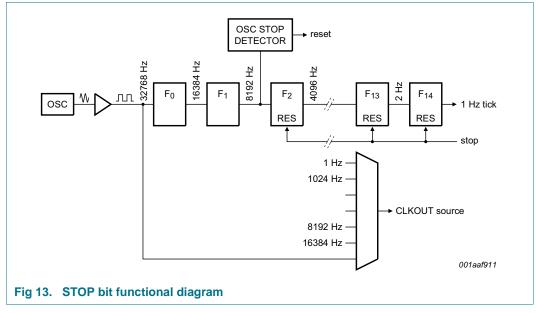
#### Operation example:

- 1. Set EXT\_TEST test mode (register Control\_1, bit EXT\_TEST = 1).
- 2. Set STOP (register Control 1, bit STOP = 1).
- 3. Clear STOP (register Control 1, bit STOP = 0).
- 4. Set time registers to desired value.
- 5. Apply 32 clock pulses to pin CLKOUT.
- 6. Read time registers to see the first change.
- 7. Apply 64 clock pulses to pin CLKOUT.
- 8. Read time registers to see the second change.

Repeat steps 7 and 8 for additional increments.

# 8.9 STOP bit function

The STOP bit function (register Control\_1, see <u>Table 6</u>) allows the accurate starting of the time circuits. The STOP bit function causes the upper part of the prescaler ( $F_2$  to  $F_{14}$ ) to be held at reset, thus no 1 Hz ticks are generated. The time circuits can then be set and do not increment until STOP is released; see <u>Figure 13</u>. STOP does not affect the output of 32.768 kHz, 16.384 kHz, or 8.192 kHz; see <u>Section 8.5</u>.



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#### SPI-bus Real-Time Clock and calendar

The lower two stages of the prescaler ( $F_0$  and  $F_1$ ) are not reset and because the SPI-bus is asynchronous to the crystal oscillator, the accuracy of restarting the time circuits is between 0 and one 8.192 kHz cycle; see <u>Figure 14</u>. The first increment of the time circuits is between 0.499878 s and 0.500000 s after STOP is released. The uncertainty is caused by prescaler bits F0 and F1 not being reset; see <u>Table 37</u>.

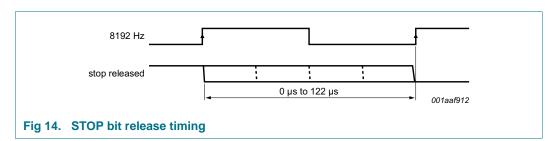


Table 37. Example: first increment of time circuits after STOP release

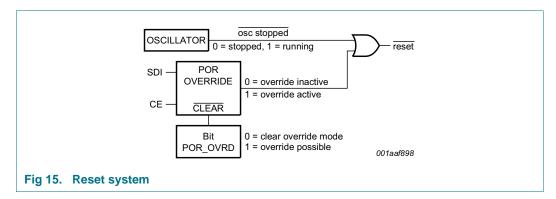
	Prescaler bits	1 Hz ti	ck	Time	Comment					
	F F 4 F [1]									
	$F_0F_1-F_2$ to $F_{14}^{[1]}$			hh:mm:ss						
Clock is rui	nning normally									
0	01-0 0001 1101 0100			12:45:12	prescaler counting normally					
STOP is ac	tivated by user. F0F1 a	re not	reset a	and values ca	nnot be predicted externally					
1	XX-0 0000 0000 0000			12:45:12	prescaler is reset; time circuits are frozen					
New time is	s set by user									
1	XX-0 0000 0000 0000			08:00:00	prescaler is reset; time circuits are frozen					
STOP is rel	eased by user									
0	XX-0 0000 0000 0000			08:00:00	prescaler is now running					
	XX-1 0000 0000 0000	0.499878 - 0.500000 s		08:00:00	-					
	XX-0 1000 0000 0000	2000		08:00:00	-					
	XX-1 1000 0000 0000	8 - 0	🏋	08:00:00	-					
	:	9987		:	:					
	11-1 1111 1111 1110	0.4	_L_	08:00:00	-					
	00-0 0000 0000 0001	1		08:00:01	0 to 1 transition of F14 increments the time circuits					
	10-0 0000 0000 0001			08:00:01	-					
	:			:	:					
	11-1 1111 1111 1111	s		08:00:01	-					
	00-0 0000 0000 0000	-	Γ	08:00:01	-					
	10-0 0000 0000 0000			08:00:01	-					
	:		Ĩ	:	:					
	11-1 1111 1111 1110			08:00:01	-					
	00-0 0000 0000 0001	<u>'</u>		08:00:02	0 to 1 transition of F14 increments the time circuits					
		001	<b>I</b> aaf913							

[1]  $F_0$  is clocked at 32.768 kHz.

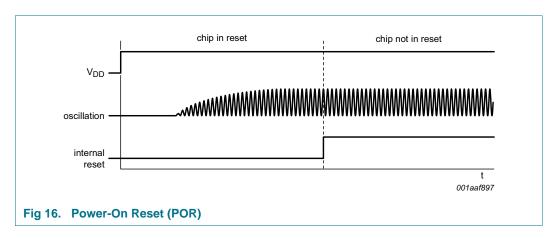
### SPI-bus Real-Time Clock and calendar

#### 8.10 Reset

The PCA21125 includes an internal reset circuit which is active whenever the oscillator is stopped; see <u>Figure 15</u>. The oscillator can be stopped, for example, by connecting one of the oscillator pins OSCI or OSCO to ground.



The oscillator is considered to be stopped during the time between power-on and stable crystal resonance; see <u>Figure 16</u>. This time can be in the range of 200 ms to 2 s depending on crystal type, temperature and supply voltage. Whenever an internal reset occurs, the reset flag RF (register Seconds, see <u>Table 8</u>) is set.



#### SPI-bus Real-Time Clock and calendar

Table 38. Register reset values

Bits labeled - are not implemented and return logic 0 when read. Bits labeled X are undefined at power-on and unchanged by subsequent resets.

Address	Register name	Bit									
		7	6	5	4	3	2	1	0		
00h	Control_1	0	0	0	-	1	0	-	-		
01h	Control_2	0	0	0	0	0	0	0	0		
02h	Seconds	1	Х	Х	Х	Х	Х	Х	Х		
03h	Minutes	-	Х	Х	Х	Х	Х	Х	Х		
04h	Hours	-	-	Х	Х	Х	Х	Х	Х		
05h	Days	-	-	Х	Х	Х	Х	Х	Х		
06h	Weekdays	-	-	-	-	-	Х	Х	Х		
07h	Months	-	-	-	Х	Х	Х	Х	Х		
08h	Years	Х	Х	Х	Х	Х	Х	Х	Х		
09h	Minute_alarm	1	Х	Х	Х	Х	Х	Х	Х		
0Ah	Hour_alarm	1	-	Х	Х	Х	X	Х	Х		
0Bh	Day_alarm	1	-	Х	Х	Х	Х	Х	Х		
0Ch	Weekday_alarm	1	-	-	-	-	Х	Х	Х		
0Dh	CLKOUT_control	-	-	-	-	-	0	0	0		
0Eh	Timer_control	0	-	-	-	-	-	1	1		
0Fh	Countdown_timer	Х	Х	Х	Х	Х	Х	Х	Х		

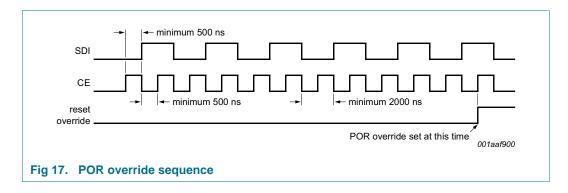
After reset, the following mode is entered:

- 32.768 kHz on pin CLKOUT active
- POR override available to be set
- 24-hour mode is selected

The SPI-bus is initialized whenever the chip enable pin CE is inactive (LOW).

# 8.10.1 POR override

The Power-On Reset (POR) duration is directly related to the crystal oscillator start-up time. Due to the long start-up times experienced by these types of circuits, a mechanism has been built in to disable the POR and hence speed up the on-board test of the device.



#### SPI-bus Real-Time Clock and calendar

The setting of this mode requires that bit POR\_OVRD (register Control\_1, see <u>Table 6</u>) be set logic 1 and that the signals at the SPI-bus pins SDI and CE are toggled as illustrated in <u>Figure 17</u>. All timings are required minimums.

Once the override mode has been entered, the device immediately stops being reset and set-up operation can commence, i.e., entry into the external clock test mode via the SPI-bus access. The override mode can be cleared by writing logic 0 to bit POR\_OVRD. Bit POR\_OVRD must be set logic 1 before a re-entry into the override mode is possible. Setting bit POR\_OVRD logic 0 during normal operation has no effect except to prevent accidental entry into the POR override mode. This is the recommended setting.

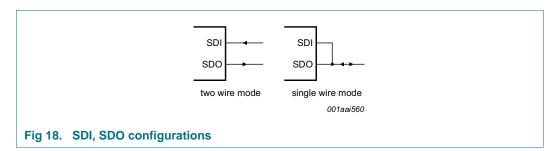
### 8.11 4-line SPI-bus

Data transfer to and from the device is made via a 4-line SPI-bus; see Table 39.

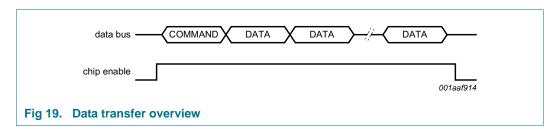
Table 39. Serial interface

Pin	Function	Description
CE	chip enable input	when HIGH, data transfer is active
		when LOW, data transfer is inactive; the interface is reset; pull-down resistor included; active input can be higher than $V_{DD}$ , but must not be wired HIGH permanently
SCL	serial clock input	when pin CE = LOW, this input might float; input can be higher than $V_{\text{DD}}$
SDI	serial data input	when pin CE = LOW, this input might float; input can be higher than $V_{DD}$ ; input data is sampled on the rising edge of SCL
SDO	serial data output	push-pull output; drives from $V_{\text{SS}}$ to $V_{\text{DD}};$ output data is changed on the falling edge of SCL

The data lines for input and output are split. The data input and output lines can be connected together to facilitate a bidirectional data bus (see <u>Figure 18</u>).



The chip enable signal is used to identify the transmitted data. Each data transfer is a byte, with the Most Significant Bit (MSB) sent first; see Figure 19.



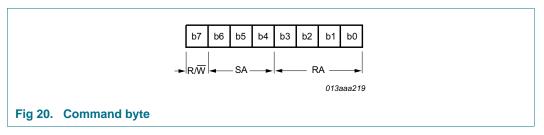
#### SPI-bus Real-Time Clock and calendar

The transmission is initiated by an active HIGH chip enable signal CE and terminated by an inactive LOW signal. The first byte transmitted is the command byte (see <u>Table 40</u> and <u>Figure 20</u>). Subsequent bytes are either data to be written or data to be read. Data is captured on the rising edge of the clock and transferred internally on the falling edge.

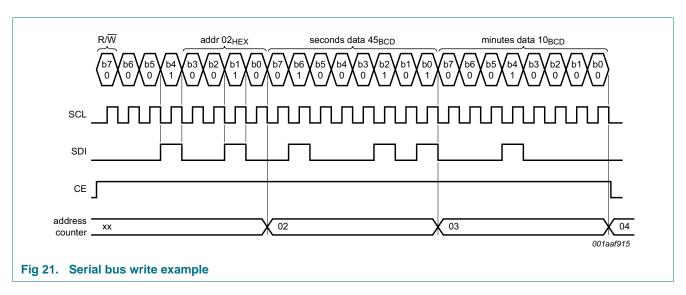
The command byte defines the address of the first register to be accessed and the read/write mode. The address counter will auto increment after every access and will reset to zero after the last valid register is accessed. The read/write bit  $(R/\overline{W})$  defines if the following bytes are read or write information.

Table 40. Command byte definition

Bit	Symbol	Value	Description
7	R/W		data read or data write selection
		0	write data
		1	read data
6 to 4	SA	001	subaddress; other codes cause the device to ignore data transfer
3 to 0	RA	00h to 0Fh	register address

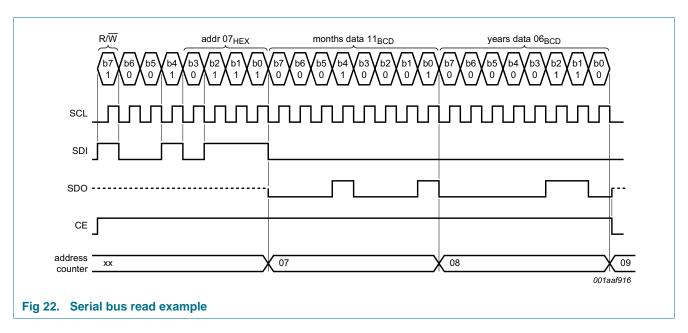


In <u>Figure 21</u>, the register Seconds is set to 45 seconds and the register Minutes to 10 minutes.



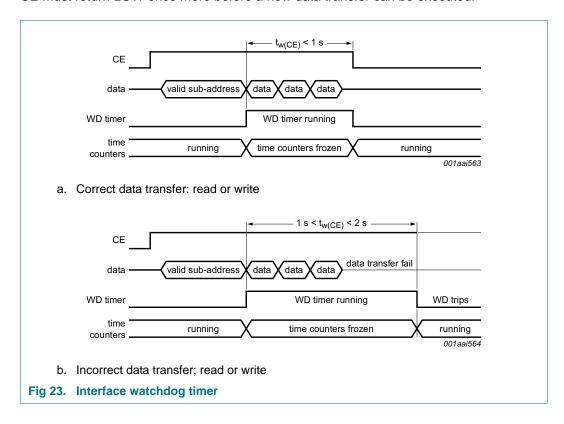
In <u>Figure 22</u>, the Months and Years registers are read. In this example, pins SDI and SDO are not connected together.

#### SPI-bus Real-Time Clock and calendar



# 8.11.1 Interface watchdog timer

During read/write operations, the time counting circuits are frozen. To prevent a situation where the accessing device becomes locked and does not clear the interface by setting pin CE LOW, the PCA21125 has a built-in watchdog timer. Should the interface be active for more than 1 s from the time a valid subaddress is transmitted, then the PCA21125 will automatically clear the interface and allow the time counting circuits to continue counting. CE must return LOW once more before a new data transfer can be executed.

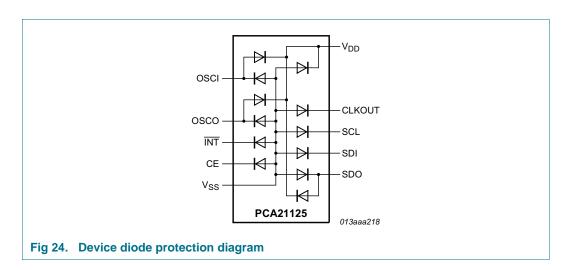


#### SPI-bus Real-Time Clock and calendar

The watchdog is implemented to prevent the excessive loss of time due to interface access failure, e.g., if main power is removed from a battery backed-up system during an interface access.

Each time the watchdog period is exceeded, 1 s is lost from the time counters. The watchdog will trigger between 1 s and 2 s after receiving a valid subaddress.

# 9. Internal circuitry



# 10. Safety notes

# CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

### SPI-bus Real-Time Clock and calendar

# 11. Limiting values

Table 41. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{DD}$	supply voltage			-0.5	+6.5	V
I <sub>DD</sub>	supply current			-50	+50	mA
VI	input voltage			-0.5	+6.5	V
Vo	output voltage			-0.5	+6.5	V
I <sub>I</sub>	input current			-10	+10	mA
Io	output current			-10	+10	mA
P <sub>tot</sub>	total power dissipation			-	300	mW
T <sub>amb</sub>	ambient temperature	operating device		-40	+125	°C
V <sub>ESD</sub>	electrostatic discharge voltage	НВМ	[1]	-	±3500	V
		MM	[2]	-	±200	V
		CDM	[3]	-	±1500	V
I <sub>lu</sub>	latch-up current		[4]	-	100	mA
T <sub>stg</sub>	storage temperature		<u>[5]</u>	-65	+150	°C

<sup>[1]</sup> Pass level; Human Body Model (HBM) according to Ref. 5 "JESD22-A114".

<sup>[2]</sup> Pass level; Machine Model (MM), according to Ref. 6 "JESD22-A115".

<sup>[3]</sup> Pass level; Charged-Device Model (CDM), according to Ref. 7 "JESD22-C101".

<sup>[4]</sup> Pass level; latch-up testing, according to Ref. 8 "JESD78" at maximum ambient temperature (T<sub>amb(max)</sub> = +125 °C).

<sup>[5]</sup> According to the store and transport requirements (see Ref. 11 "UM10569") the devices have to be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to 75 %.

### SPI-bus Real-Time Clock and calendar

# 12. Static characteristics

# Table 42. Static characteristics

 $V_{DD}=1.3~V~to~5.5~V;~V_{SS}=0~V;~T_{amb}=-40~^{\circ}C~to~+125~^{\circ}C;~f_{osc}=32.768~kHz;~quartz~R_{s}=60~k\Omega;~C_{L}=12.5~pF;~unless~otherwise~specified.$ 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supply: p	in V <sub>DD</sub>		-			
$V_{DD}$	supply voltage	SPI-bus inactive; [1] for clock data integrity	1.3	-	5.5	V
		SPI-bus active	1.6	-	5.5	V
I <sub>DD</sub>	supply current	SPI-bus active				
		f <sub>SCL</sub> = 6.0 MHz	-	-	500	μΑ
		f <sub>SCL</sub> = 1.0 MHz	-	-	100	μА
		SPI-bus inactive; [2] CLKOUT disabled; VDD = 2.0 V to 5.0 V				
		T <sub>amb</sub> = 25 °C	-	820	-	nA
		$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	-	1140	3300	nA
		SPI-bus inactive (f <sub>SCL</sub> = 0 Hz); CLKOUT enabled at 32 kHz				
		T <sub>amb</sub> = 25 °C				
		V <sub>DD</sub> = 5.0 V	-	1220	-	nΑ
		V <sub>DD</sub> = 3.0 V	-	940	-	nA
		V <sub>DD</sub> = 2.0 V	-	810	-	nΑ
		$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$			·	
		V <sub>DD</sub> = 5.0 V	-	-	4000	nA
		V <sub>DD</sub> = 3.0 V	-	-	2400	nA
		V <sub>DD</sub> = 2.0 V	-	-	1900	nA
Inputs					·	
VI	input voltage	pin OSCI	-0.5	-	V <sub>DD</sub> + 0.5	V
		pins CE, SDI, SCL	-0.5	-	+5.5	V
V <sub>IL</sub>	LOW-level input voltage		$V_{SS}$	-	$0.3V_{DD}$	V
V <sub>IH</sub>	HIGH-level input voltage		$0.7V_{DD}$	-	$V_{DD}$	V
I <sub>L</sub>	leakage current	$V_I = V_{DD}$ or $V_{SS}$ ; on pins SDI, SCL and CLKOUT	<b>-1</b>	0	+1	μА
Cı	input capacitance	[3]	-	-	7	pF
R <sub>pd</sub>	pull-down resistance	pin CE	-	240	550	kΩ
Outputs	·		•		•	
Vo	output voltage	pins OSCO and SDO	-	-	$V_{DD} + 0.5$	V
		pins CLKOUT and INT; refers to external pull-up voltage	-	-	5.5	V
V <sub>OH</sub>	HIGH-level output voltage	pin SDO	0.8V <sub>DD</sub>	-	$V_{DD}$	V

### **SPI-bus Real-Time Clock and calendar**

Table 42. Static characteristics ... continued

 $V_{DD}$  = 1.3 V to 5.5 V;  $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +125 °C;  $f_{osc}$  = 32.768 kHz; quartz  $R_s$  = 60 k $\Omega$ ;  $C_L$  = 12.5 pF; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{OL}$	LOW-level output voltage	pin SDO	$V_{SS}$	-	0.2V <sub>DD</sub>	V
		pins CLKOUT and INT; V <sub>DD</sub> = 5 V; I <sub>OL</sub> = -1.5 mA	V <sub>SS</sub>	-	0.4	V
Гон	HIGH-level output current	output source current; pin SDO; $V_{OH} = 4.6 \text{ V};$ $V_{DD} = 5 \text{ V}$	1.5	-	-	mA
I <sub>OL</sub>	LOW-level output current	output sink current; pins INT, SDO and CLKOUT; V <sub>OL</sub> = 0.4 V; V <sub>DD</sub> = 5 V	1.5	-	-	mA
I <sub>LO</sub>	output leakage current	$V_O = V_{DD}$ or $V_{SS}$	-1	0	+1	μΑ
C <sub>ext</sub>	external capacitance	[4]	-	25	-	pF
Cosco	capacitance on pin OSCO	[4]	-	25	-	pF

- [1] For reliable oscillator start at power-up:  $V_{DD} = V_{DD(min)} + 0.3 \text{ V}$ .
- [2] Timer source clock =  $\frac{1}{60}$  Hz; voltage on pins CE, SDI and SCL at  $V_{DD}$  or  $V_{SS}$ .
- [3] Implicit by design.
- [4]  $C_L$  is a calculation of  $C_{ext}$  and  $C_{OSCO}$  in series:  $C_L = \frac{(C_{ext} \cdot C_{OSCO})}{(C_{ext} + C_{OSCO})}$ .

### SPI-bus Real-Time Clock and calendar

# 13. Dynamic characteristics

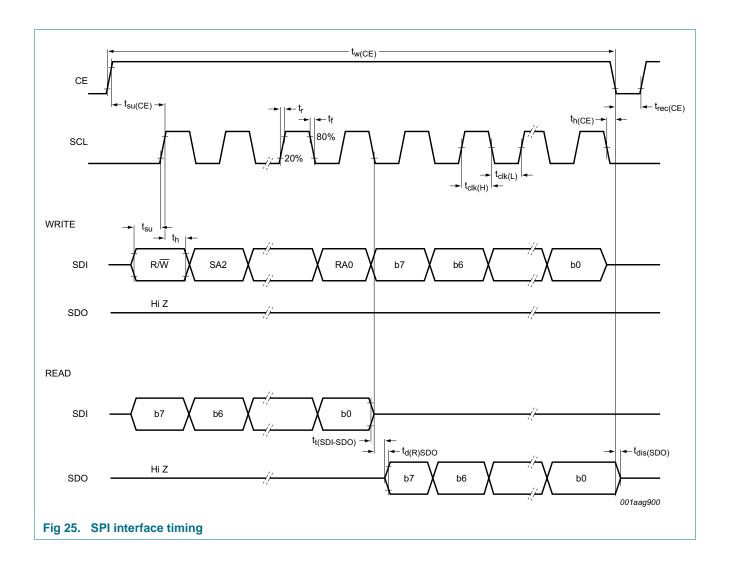
# Table 43. Dynamic characteristics

 $V_{DD}$  = 1.6 V to 5.5 V;  $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +125 °C; all timing values are valid within the operating supply voltage at ambient temperature and referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ .

Symbol	Parameter	Conditions		V <sub>DD</sub> =	1.6 V	$V_{DD} = 2.7 \text{ V}$		$V_{DD} = 4.5 V$		$V_{DD} = 5.5 V$		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
Pin SCL												
f <sub>clk(SCL)</sub>	SCL clock frequency			-	1.5	-	4.0	-	5.00	-	6.25	MHz
t <sub>SCL</sub>	SCL time			660	-	250	-	200	-	160	-	ns
t <sub>clk(H)</sub>	clock HIGH time			320	-	120	-	100	-	70	-	ns
t <sub>clk(L)</sub>	clock LOW time			320	-	130	-	100	-	90	-	ns
t <sub>r</sub>	rise time	for SCL signal		-	100	-	100	-	100	-	100	ns
t <sub>f</sub>	fall time	for SCL signal		-	100	-	100	-	100	-	100	ns
Pin CE			,									
t <sub>su(CE)</sub>	CE set-up time			30	-	30	-	30	-	30	-	ns
t <sub>h(CE)</sub>	CE hold time			100	-	60	-	40	-	30	-	ns
t <sub>rec(CE)</sub>	CE recovery time			100	-	100	-	100	-	100	-	ns
t <sub>w(CE)</sub>	CE pulse width			-	0.99	-	0.99	-	0.99	-	0.99	s
Pin SDI			,									
t <sub>su</sub>	set-up time			25	-	15	-	15	-	10	-	ns
t <sub>h</sub>	hold time			100	-	60	-	40	-	30	-	ns
Pin SDO			,									
t <sub>d(R)SDO</sub>	SDO read delay time	bus load = 85 pF		-	320	-	130	-	100	-	90	ns
t <sub>dis(SDO)</sub>	SDO disable time	no load value	[1]	-	50	-	30	-	30	-	25	ns
t <sub>t(SDI-SDO)</sub>	transition time from SDI to SDO	to avoid bus conflict		0	-	0	-	0	-	0	-	ns

<sup>[1]</sup> Bus is held up by bus capacitance; use RC time constant with application values.

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SPI-bus Real-Time Clock and calendar

# 14. Application information

# 14.1 Application diagram

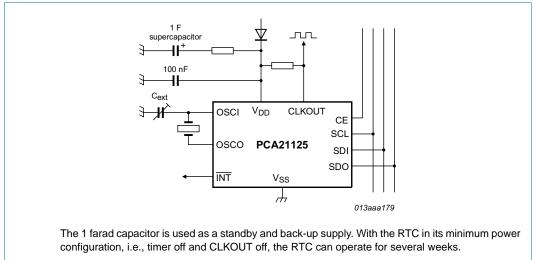


Fig 26. Application diagram

# 14.2 Quartz frequency adjustment

1. Method 1: fixed OSCI capacitor

A fixed capacitor can be used whose value can be determined by evaluating the average capacitance necessary for the application layout; see <u>Figure 26</u>. The frequency is best measured via the 32.768 kHz signal at pin CLKOUT available after power-on. The frequency tolerance depends on the quartz crystal tolerance, the capacitor tolerance and the device-to-device tolerance (on average  $\pm 5 \times 10^{-6}$ ). An average deviation of  $\pm 5$  minutes per year can easily be achieved.

2. Method 2: OSCI trimmer

Fast setting of a trimmer is possible using the 32.768 kHz signal at pin CLKOUT available after power-on.

3. Method 3: OSCO output

Direct measurement of OSCO output (accounting for test probe capacitance).

# 15. Test information

# 15.1 Quality information

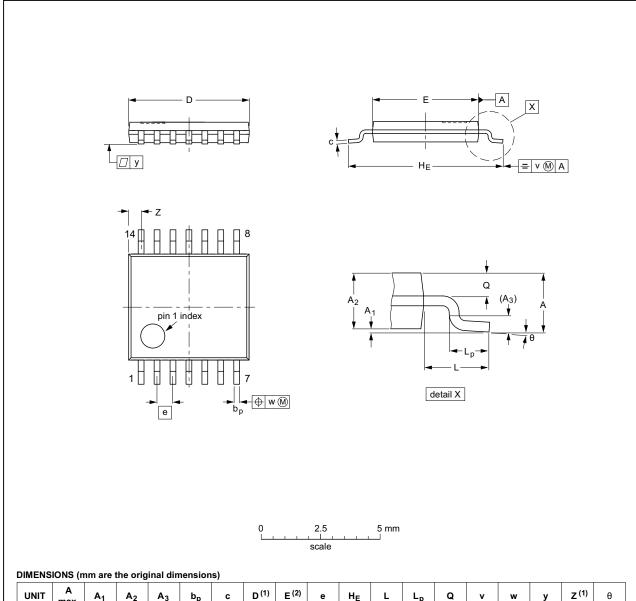
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q100 - Failure mechanism based stress test qualification for integrated circuits*, and is suitable for use in automotive applications.

### SPI-bus Real-Time Clock and calendar

# 16. Package outline

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



UNIT	max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	С	D (1)	E (2)	е	HE	L	Lp	Q	V	w	у	Z (1)	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included

REFE	.INE	EUROPEAN	ISSUE DATE			
JEDEC	ION	JEITA		PROJECTION	ISSUE DATE	
MO-153	02-1				<del>99-12-27</del> 03-02-18	
MO-153	02-1					

Fig 27. Package outline SOT402-1 (TSSOP14)

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# 17. Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling Metal-Oxide Semiconductor (MOS) devices ensure that all normal precautions are taken as described in *JESD625-A*, *IEC 61340-5* or equivalent standards.

# 18. Packing information

## 18.1 Tape and reel information

For tape and reel packing information, see Ref. 10 "SOT402-1\_118" on page 43.

# 19. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365* "Surface mount reflow soldering description".

## 19.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

## 19.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages

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- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

# 19.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

# 19.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 28</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 44 and 45

Table 44. SnPb eutectic process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)					
	Volume (mm³)					
	< 350	≥ 350				
< 2.5	235	220				
≥ 2.5	220	220				

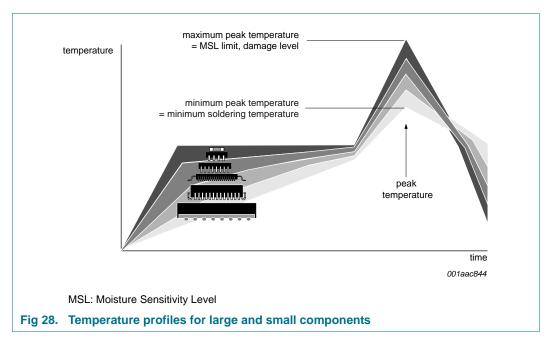
Table 45. Lead-free process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)						
	Volume (mm³)						
	< 350	350 to 2000	> 2000				
< 1.6	260	260	260				
1.6 to 2.5	260	250	245				
> 2.5	250	245	245				

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 28.

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For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

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# 20.1 Real-Time Clock selection

Table 46. Selection of Real-Time Clocks

Type name	Alarm, Timer, Watchdog	Interrupt output	Interface	I <sub>DD</sub> , typical (nA)	Battery backup	Timestamp, tamper input	AEC-Q100 compliant	Special features	Packages
PCF8563	Х	1	I <sup>2</sup> C	250	-	-	-	-	SO8, TSSOP8, HVSON10
PCF8564A	Х	1	I <sup>2</sup> C	250	-	-	-	integrated oscillator caps	WLCSP
PCA8565	Х	1	I <sup>2</sup> C	600	-	-	grade 1	high robustness, T <sub>amb</sub> = -40 °C to 125 °C	TSSOP8, HVSON10
PCA8565A	Х	1	I <sup>2</sup> C	600	-	-	-	integrated oscillator caps, T <sub>amb</sub> = -40 °C to 125 °C	WLCSP
PCF85063	-	1	I <sup>2</sup> C	220	-	-	-	basic functions only, no alarm	HXSON8
PCF85063A	Х	1	I <sup>2</sup> C	220	-	-	-	tiny package	SO8, DFN2626-10
PCF85063B	Х	1	SPI	220	-	-	-	tiny package	DFN2626-10
PCF85263A	X	2	I <sup>2</sup> C	230	X	Х	-	time stamp, battery backup, stopwatch ½100 s	SO8, TSSOP10, TSSOP8, DFN2626-10
PCF85263B	Х	2	SPI	230	Х	Х	-	time stamp, battery backup, stopwatch ½100s	TSSOP10, DFN2626-10
PCF85363A	X	2	I <sup>2</sup> C	230	X	Х	-	time stamp, battery backup, stopwatch ½100s, 64 Byte RAM	TSSOP10, DFN2626-10
PCF85363B	X	2	SPI	230	X	Х	-	time stamp, battery backup, stopwatch ½ <sub>100</sub> s, 64 Byte RAM	TSSOP10, DFN2626-10
PCF8523	Х	2	I <sup>2</sup> C	150	X	-	-	lowest power 150 nA in operation, FM+ 1 MHz	SO8, HVSON8, TSSOP14, WLCSP
PCF2123	Х	1	SPI	100	-	-	-	lowest power 100 nA in operation	TSSOP14, HVQFN16
PCF2127	X	1	I <sup>2</sup> C and SPI	500	Х	Х	-	temperature compensated, quartz built in, calibrated, 512 Byte RAM	SO16

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Type name	Alarm, Timer, Watchdog	Interrupt output	Interface	I <sub>DD</sub> , typical (nA)	Battery backup	Timestamp, tamper input	AEC-Q100 compliant	Special features	Packages
PCF2127A	Х	1	I <sup>2</sup> C and SPI	500	X	Х	-	temperature compensated, quartz built in, calibrated, 512 Byte RAM	SO20
PCF2129	Х	1	I <sup>2</sup> C and SPI	500	X	Х	-	temperature compensated, quartz built in, calibrated	SO16
PCF2129A	Х	1	I <sup>2</sup> C and SPI	500	X	Х	-	temperature compensated, quartz built in, calibrated	SO20
PCA2129	X	1	I <sup>2</sup> C and SPI	500	X	Х	grade 3	temperature compensated, quartz built in, calibrated	SO16
PCA21125	Х	1	SPI	820	-	-	grade 1	high robustness, T <sub>amb</sub> = -40 °C to 125 °C	TSSOP14

### SPI-bus Real-Time Clock and calendar

## 21. Abbreviations

Table 47. Abbreviations

Acronym	Description
AEC	Automotive Electronics Council
AM	Ante Meridiem
BCD	Binary Coded Decimal
CDM	Charged-Device Model
CMOS	Complementary Metal Oxide Semiconductor
HBM	Human Body Model
IC	Integrated Circuit
MM	Machine Model
MOS	Metal Oxide Semiconductor
MSB	Most Significant Bit
MSL	Moisture Sensitivity Level
PCB	Printed-Circuit Board
PM	Post Meridiem
POR	Power-On Reset
RC	Resistance-Capacitance
RTC	Real-Time Clock
SMD	Surface Mount Device
SPI	Serial Peripheral Interface

## 22. References

- [1] AN10365 Surface mount reflow soldering description
- [2] IEC 60134 Rating systems for electronic tubes and valves and analogous semiconductor devices
- [3] IEC 61340-5 Protection of electronic devices from electrostatic phenomena
- [4] IPC/JEDEC J-STD-020D Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices
- [5] JESD22-A114 Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [6] **JESD22-A115** Electrostatic Discharge (ESD) Sensitivity Testing Machine Model (MM)
- [7] **JESD22-C101** Field-Induced Charged-Device Model Test Method for Electrostatic-Discharge-Withstand Thresholds of Microelectronic Components
- [8] JESD78 IC Latch-Up Test
- [9] **JESD625-A** Requirements for Handling Electrostatic-Discharge-Sensitive (ESDS) Devices
- [10] SOT402-1\_118 TSSOP14; Reel pack; SMD, 13", packing information
- [11] UM10569 Store and transport requirements

# SPI-bus Real-Time Clock and calendar

# 23. Revision history

## Table 48. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes				
PCA21125 v.2	20141125	Product data sheet	-	PCA21125 v.1				
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guideline of NXP Semiconductors.</li> </ul>							
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>							
	<ul> <li>Corrected dela</li> </ul>	ay time of first increment of the	e time circuits					
	<ul> <li>Added C<sub>OSCO</sub> value in <u>Table 42</u></li> </ul>							
	Added <u>Section 18.1</u> and <u>Section 20.1</u>							
	Fixed typos							
PCA21125 v.1	20091116	Product data sheet	-	-				

### SPI-bus Real-Time Clock and calendar

# 24. Legal information

### 24.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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### **SPI-bus Real-Time Clock and calendar**

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